

Turbo2 ultrafast - high voltage rectifier for flat panel displays

Features

- ultrafast switching
- low reverse current
- low thermal resistance
- reduces conduction and switching losses
- insulated package TO-220FPAC:
 - insulated voltage: 2500 V rms
 - typical package capacitance: 12 pF

Description

The STTH10LCD06 uses ST Turbo2 technology. This device is suited for power applications in flat panel displays and especially applicable to switching power supplies in LCDs.

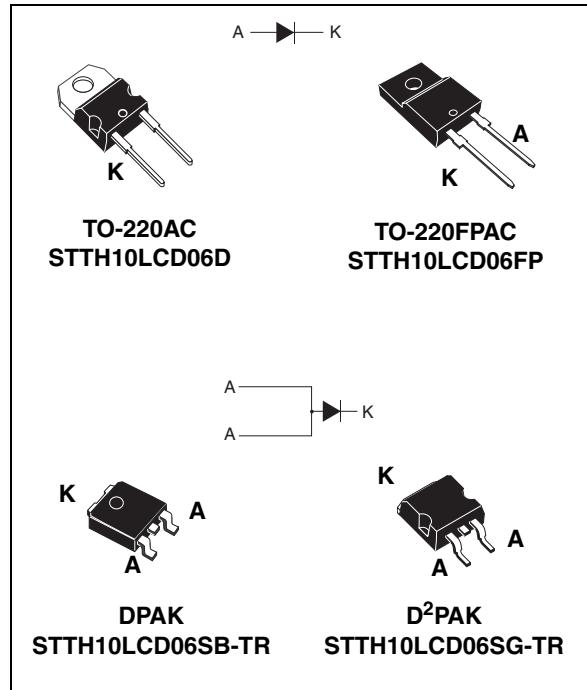


Table 1. Device summary

| | |
|----------------|--------|
| $I_{F(AV)}$ | 10 A |
| V_{RRM} | 600 V |
| T_j | 175 °C |
| V_F (typ) | 1.3 V |
| t_{rr} (max) | 50 ns |

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

| Symbol | Parameter | | | Value | Unit |
|---------------------|---|--|------------------------------------|--------------|------|
| V _{RRM} | Repetitive peak reverse voltage | | | 600 | V |
| I _{F(RMS)} | Forward current rms | DPAK | | | 18 |
| | | TO-220AC, TO-220FPAC, D ² PAK | | | 35 |
| I _{F(AV)} | Average forward current, $\delta = 0.5$ | T _c = 105 °C | TO-220AC, DPAK, D ² PAK | | 10 |
| | | T _c = 55 °C | TO-220FPAC, | | 10 |
| I _{FSM} | Surge non repetitive forward current | t _p = 10 ms sinusoidal | | | 100 |
| T _{stg} | Storage temperature range | | | -65 to + 175 | °C |
| T _j | Maximum operating junction temperature ⁽¹⁾ | | | 175 | °C |

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

| Symbol | Parameter | | Value | Unit |
|----------------------|------------------|--|------------------------------------|------|
| R _{th(j-c)} | Junction to case | | TO-220AC, DPAK, D ² PAK | 3.5 |
| | | | TO-220FPAC | 6 |

Table 4. Static electrical characteristics

| Symbol | Parameter | Test conditions | | Min. | Typ. | Max. | Unit |
|-------------------------------|-------------------------|-------------------------|-----------------------------------|------|------|------|------|
| I _R ⁽¹⁾ | Reverse leakage current | T _j = 25 °C | V _R = V _{RRM} | - | - | 5 | μA |
| | | T _j = 150 °C | | - | 13 | 130 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 25 °C | I _F = 10 A | - | - | 2 | V |
| | | T _j = 150 °C | | - | 1.3 | 1.6 | |

1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 μs, δ < 2 %

To evaluate the conduction losses use the following equation:

$$P = 1.20 \times I_{F(AV)} + 0.040 \times I_{F(RMS)}^2$$

Table 5. Dynamic electrical characteristics

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|--------------------------|---|------|------|------|------|
| t _{rr} | Reverse recovery time | I _F = 1 A, dI _F /dt = -50 A/μs, V _R = 30 V, T _j = 25 °C | - | 35 | 50 | ns |
| I _{RM} | Reverse recovery current | I _F = 10 A, dI _F /dt = -50 A/μs, V _R = 400 V, T _j = 125 °C | - | 2.0 | 2.8 | A |
| t _{fr} | Forward recovery time | I _F = 10 A, dI _F /dt = 100 A/μs, V _{FR} = 1.1 x V _{Fmax} , T _j = 25 °C | - | - | 230 | ns |
| V _{FP} | Forward recovery voltage | I _F = 10 A, dI _F /dt = 100 A/μs, V _{FR} = 1.1 x V _{Fmax} , T _j = 25 °C | - | 4 | - | V |

Figure 1. Conduction losses versus average current

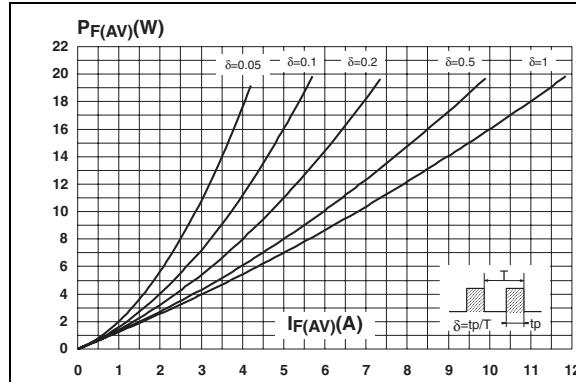


Figure 2. Forward voltage drop versus forward current

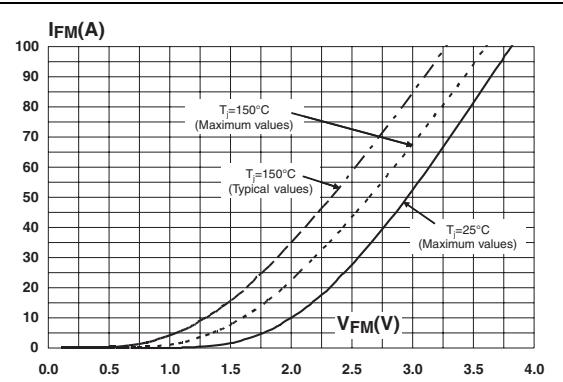


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

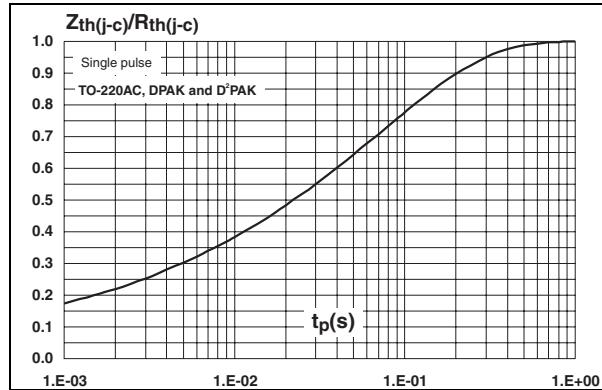


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAC)

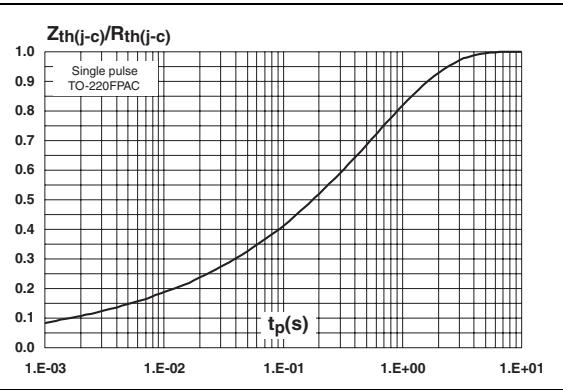


Figure 5. Peak reverse recovery current versus dI_F/dt (typical values)

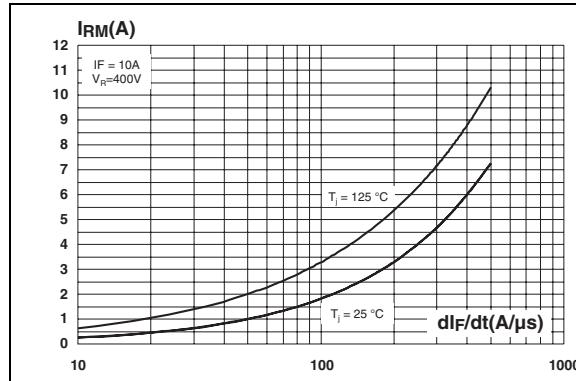


Figure 6. Reverse recovery time versus dI_F/dt (typical values)

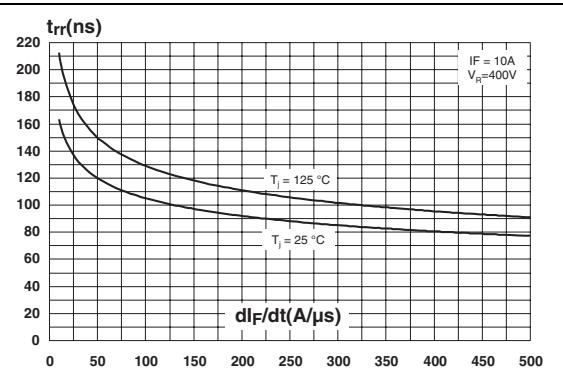


Figure 7. Reverse recovery charges versus dI_F/dt (typical values)

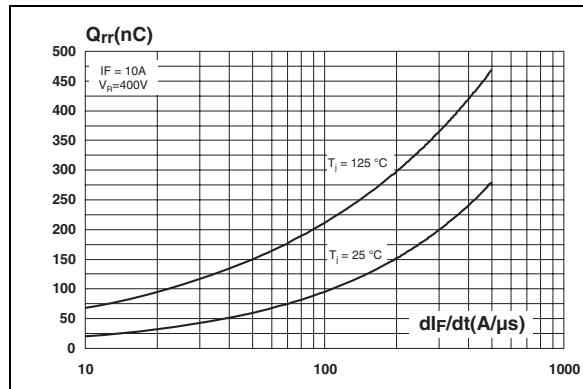


Figure 8. Relative variations of dynamic parameters versus junction temperature

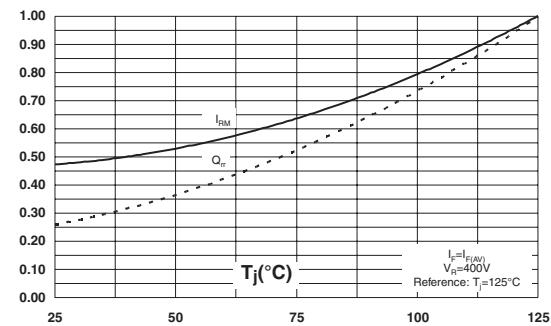


Figure 9. Transient peak forward voltage versus dI_F/dt (typical values)

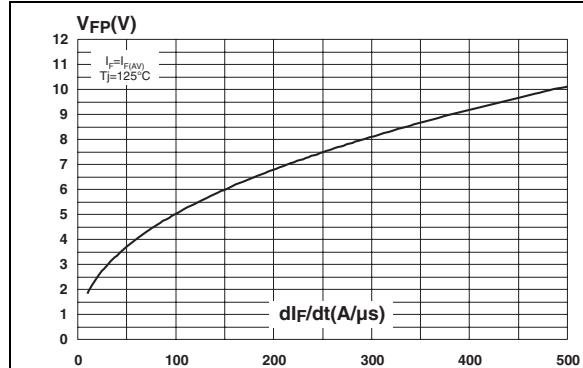


Figure 10. Forward recovery time versus dI_F/dt (typical values)

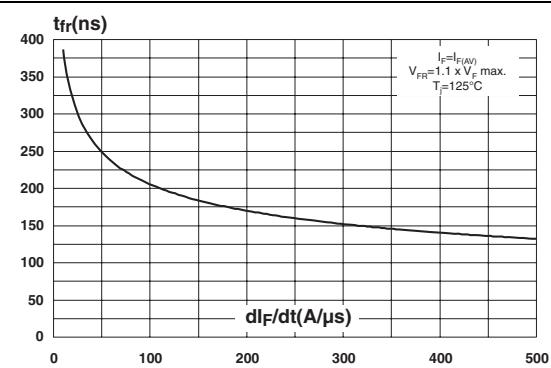
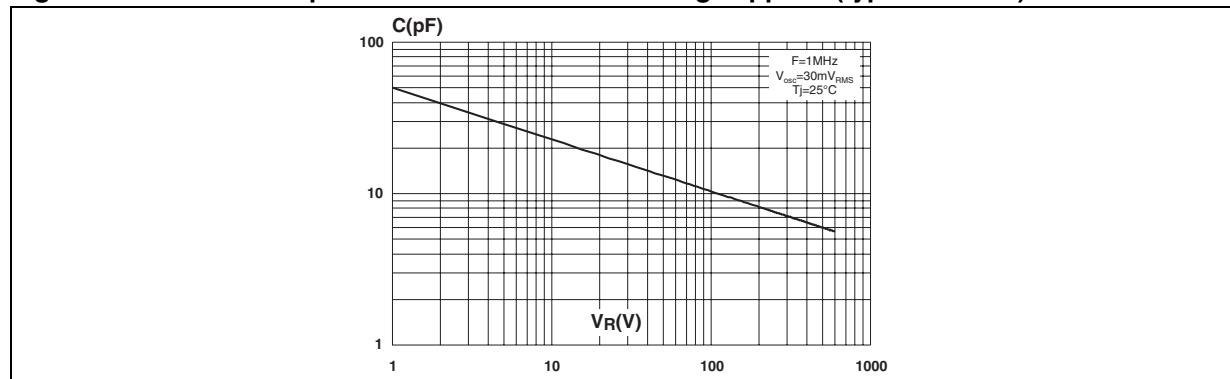


Figure 11. Junction capacitance versus reverse voltage applied (typical values)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

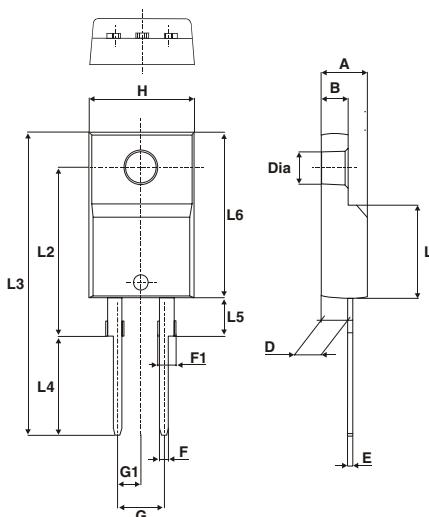
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Table 6. TO-220AC dimensions

| Ref. | Dimensions | | | |
|---------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.40 | 4.60 | 0.173 | 0.181 |
| C | 1.23 | 1.32 | 0.048 | 0.051 |
| D | 2.40 | 2.72 | 0.094 | 0.107 |
| E | 0.49 | 0.70 | 0.019 | 0.027 |
| F | 0.61 | 0.88 | 0.024 | 0.034 |
| F1 | 1.14 | 1.70 | 0.044 | 0.066 |
| G | 4.95 | 5.15 | 0.194 | 0.202 |
| H2 | 10.00 | 10.40 | 0.393 | 0.409 |
| L2 | 16.40 typ. | | 0.645 typ. | |
| L4 | 13.00 | 14.00 | 0.511 | 0.551 |
| L5 | 2.65 | 2.95 | 0.104 | 0.116 |
| L6 | 15.25 | 15.75 | 0.600 | 0.620 |
| L7 | 6.20 | 6.60 | 0.244 | 0.259 |
| L9 | 3.50 | 3.93 | 0.137 | 0.154 |
| M | 2.6 typ. | | 0.102 typ. | |
| Diam. I | 3.75 | 3.85 | 0.147 | 0.151 |

Table 7. TO-220FPAC dimensions

| Ref. | Dimensions | | | |
|------|-------------|------|-----------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.4 | 4.6 | 0.173 | 0.181 |
| B | 2.5 | 2.7 | 0.098 | 0.106 |
| D | 2.5 | 2.75 | 0.098 | 0.108 |
| E | 0.45 | 0.70 | 0.018 | 0.027 |
| F | 0.75 | 1 | 0.030 | 0.039 |
| F1 | 1.15 | 1.70 | 0.045 | 0.067 |
| G | 4.95 | 5.20 | 0.195 | 0.205 |
| G1 | 2.4 | 2.7 | 0.094 | 0.106 |
| H | 10 | 10.4 | 0.393 | 0.409 |
| L2 | 16 Typ. | | 0.63 Typ. | |
| L3 | 28.6 | 30.6 | 1.126 | 1.205 |
| L4 | 9.8 | 10.6 | 0.386 | 0.417 |
| L5 | 2.9 | 3.6 | 0.114 | 0.142 |
| L6 | 15.9 | 16.4 | 0.626 | 0.646 |
| L7 | 9.00 | 9.30 | 0.354 | 0.366 |
| Dia. | 3.00 | 3.20 | 0.118 | 0.126 |



The technical drawing illustrates the physical dimensions of the TO-220FPAC package. It features a central cylindrical body with two flat metal leads extending downwards. The top view shows the height of the body (H) and the lead spacing (L6). The side cross-section provides detailed dimensions for the body height (L3), lead height (L2), lead thickness (L4), lead spacing (L5), lead length (L7), and the diameter of the cylindrical body (Dia.). Other labels include A, B, C, D, E, F, G, F1, and G1, which likely refer to specific feature locations or alternative dimensioning points.

Table 8. DPAK dimensions

| Ref. | Dimensions | | | |
|------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 2.20 | 2.40 | 0.086 | 0.094 |
| A1 | 0.90 | 1.10 | 0.035 | 0.043 |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 |
| B | 0.64 | 0.90 | 0.025 | 0.035 |
| B2 | 5.20 | 5.40 | 0.204 | 0.212 |
| C | 0.45 | 0.60 | 0.017 | 0.023 |
| C2 | 0.48 | 0.60 | 0.018 | 0.023 |
| D | 6.00 | 6.20 | 0.236 | 0.244 |
| E | 6.40 | 6.60 | 0.251 | 0.259 |
| G | 4.40 | 4.60 | 0.173 | 0.181 |
| H | 9.35 | 10.10 | 0.368 | 0.397 |
| L2 | 0.80 typ. | | 0.031 typ. | |
| L4 | 0.60 | 1.00 | 0.023 | 0.039 |
| V2 | 0° | 8° | 0° | 8° |

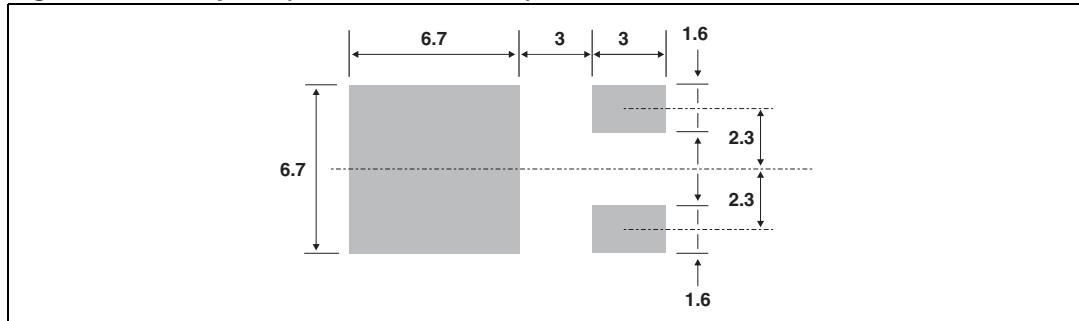
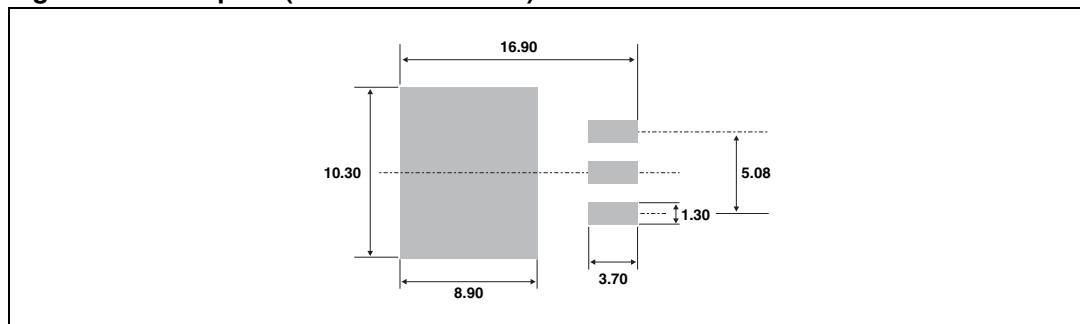
Figure 12. Footprint (dimensions in mm)

Table 9. D²PAK dimensions

| Ref. | Dimensions | | | |
|------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.40 | 4.60 | 0.173 | 0.181 |
| A1 | 2.49 | 2.69 | 0.098 | 0.106 |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 |
| B | 0.70 | 0.93 | 0.027 | 0.037 |
| B2 | 1.14 | 1.70 | 0.045 | 0.067 |
| C | 0.45 | 0.60 | 0.017 | 0.024 |
| C2 | 1.23 | 1.36 | 0.048 | 0.054 |
| D | 8.95 | 9.35 | 0.352 | 0.368 |
| E | 10.00 | 10.40 | 0.393 | 0.409 |
| G | 4.88 | 5.28 | 0.192 | 0.208 |
| L | 15.00 | 15.85 | 0.590 | 0.624 |
| L2 | 1.27 | 1.40 | 0.050 | 0.055 |
| L3 | 1.40 | 1.75 | 0.055 | 0.069 |
| M | 2.40 | 3.20 | 0.094 | 0.126 |
| R | 0.40 typ. | | 0.016 typ. | |
| V2 | 0° | 8° | 0° | 8° |

Figure 13. Footprint (dimensions in mm)

3 Ordering information

Table 10. Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|------------------|---------------|--------------------|--------|-----------|---------------|
| STTH10LCD06D | STTH10LCD06D | TO-220AC | 1.86 g | 50 | Tube |
| STTH10LCD06FP | STTH10LCD06FP | TO-220FPAC | 1.8 g | 50 | Tube |
| STTH10LCD06SG-TR | STTH10LCD06SG | D ² PAK | 1.8 g | 1000 | Tape and reel |
| STTH10LCD06SB-TR | TH10LCD06SB | DPAK | 1.8 g | 2500 | Tape and reel |

4 Revision history

Table 11. Document revision history

| Date | Revision | Description of changes |
|-------------|----------|--|
| 15-Jul-2009 | 1 | First issue |
| 30-Sep-2010 | 2 | Updated value of I _{FSM} in Table 2 . |

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